



RELIABILITY REPORT
FOR
MAX2120CTI+T
PLASTIC ENCAPSULATED DEVICES

November 15, 2011

MAXIM INTEGRATED PRODUCTS

120 SAN GABRIEL DR.
SUNNYVALE, CA 94086

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| Approved by |
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| Quality Assurance |
| Manager, Reliability Engineering |

Conclusion

The MAX2120CTI+T successfully meets the quality and reliability standards required of all Maxim products. In addition, Maxim's continuous reliability monitoring program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards.

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I. Device Description

A. General

The MAX2120 low-cost, direct-conversion tuner IC is designed for satellite set-top and VSAT applications. The IC is intended for QPSK, Digital Video Broadcast (DVB-S), DSS, and free-to-air applications. The MAX2120 directly converts the satellite signals from the LNB to baseband using a broadband I/Q downconverter. The operating frequency range extends from 925MHz to 2175MHz. The device includes an LNA and an RF variable-gain amplifier, I and Q downconverting mixers, and baseband lowpass filters with programmable cutoff frequency control and digitally controlled baseband variable-gain amplifiers. Together, the RF and baseband variable-gain amplifiers provide more than 80dB of gain-control range. The IC is compatible with virtually all QPSK demodulators. The MAX2120 includes fully monolithic VCOs, as well as a complete frequency synthesizer. Additionally, an on-chip crystal oscillator is provided along with a buffered output for driving additional tuners and demodulators. Synthesizer programming and device configuration are accomplished with a 2-wire serial interface. The IC features a VCO autoselect (VAS) function that automatically selects the proper VCO. For multituner applications, the device can be configured to have one of two 2-wire interface addresses. A low-power standby mode is available whereupon the signal path is shut down while leaving the reference oscillator, digital interface, and buffer circuits active, providing a method to reduce power in single and multituner applications. The MAX2120 is the most advanced DBS tuner available today. The low noise figure eliminates the need for an external LNA. A small number of passive components are needed to form a complete DVB, DBS, or VSAT RF front-end solution. The tuner is available in a very small 28-pin thin QFN package.

II. Manufacturing Information

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|----------------------------------|--|
| A. Description/Function: | Complete, Direct-Conversion Tuner for DVB-S and Free-to-Air Applications |
| B. Process: | MB3 |
| C. Number of Device Transistors: | |
| D. Fabrication Location: | USA |
| E. Assembly Location: | China, Malaysia, Taiwan and Thailand |
| F. Date of Initial Production: | June 27, 2007 |

III. Packaging Information

| | |
|--|--------------------------|
| A. Package Type: | 28-pin TQFN 5x5 |
| B. Lead Frame: | Copper |
| C. Lead Finish: | 100% matte Tin |
| D. Die Attach: | Conductive |
| E. Bondwire: | Au (1 mil dia.) |
| F. Mold Material: | Epoxy with silica filler |
| G. Assembly Diagram: | #05-9000-2339 |
| H. Flammability Rating: | Class UL94-V0 |
| I. Classification of Moisture Sensitivity per JEDEC standard J-STD-020-C | Level 1 |
| J. Single Layer Theta Ja: | 47°C/W |
| K. Single Layer Theta Jc: | 2°C/W |
| L. Multi Layer Theta Ja: | 29°C/W |
| M. Multi Layer Theta Jc: | 2°C/W |

IV. Die Information

| | |
|----------------------------|---|
| A. Dimensions: | 98 X 84 mils |
| B. Passivation: | BCB |
| C. Interconnect: | Al with top layer 100% Cu |
| D. Backside Metallization: | None |
| E. Minimum Metal Width: | Metal1 = 0.3 / Metal2 = 0.6 / Metal3 = 1.2 / Metal 4 = 4 microns (as drawn) |
| F. Minimum Metal Spacing: | Metal1 = 0.3 / Metal2 = 0.5 / Metal3 = 1.2 / Metal 4 = 4 microns (as drawn) |
| G. Bondpad Dimensions: | |
| H. Isolation Dielectric: | SiO ₂ |
| I. Die Separation Method: | Wafer Saw |

V. Quality Assurance Information

- A. Quality Assurance Contacts: Richard Aburano (Manager, Reliability Engineering)
Don Lipps (Manager, Reliability Engineering)
Bryan Preeshl (Vice President of QA)
- B. Outgoing Inspection Level: 0.1% for all electrical parameters guaranteed by the Datasheet.
0.1% For all Visual Defects.
- C. Observed Outgoing Defect Rate: < 50 ppm
- D. Sampling Plan: Mil-Std-105D

VI. Reliability Evaluation

A. Accelerated Life Test

The results of the 135C biased (static) life test are shown in Table 1. Using these results, the Failure Rate (λ) is calculated as follows:

$$\lambda = \frac{1}{\text{MTTF}} = \frac{1.83}{192 \times 4340 \times 48 \times 2} \quad (\text{Chi square value for MTTF upper limit})$$

(where 4340 = Temperature Acceleration factor assuming an activation energy of 0.8eV)

$$\lambda = 22.9 \times 10^{-9}$$

$$\lambda = 22.9 \text{ F.I.T. (60\% confidence level @ 25}^\circ\text{C)}$$

The following failure rate represents data collected from Maxim's reliability monitor program. Maxim performs quarterly life test monitors on its processes. This data is published in the Reliability Report found at <http://www.maxim-ic.com/qa/reliability/monitor>. Cumulative monitor data for the MB3 Process results in a FIT Rate of 0.06 @ 25C and 1.04 @ 55C (0.8 eV, 60% UCL)

B. E.S.D. and Latch-Up Testing (lot SY20F3014D, D/C 0716)

The WG17 die type has been found to have all pins able to withstand a HBM transient pulse of +/- 2500V per JEDEC JESD22-A114. Latch-Up testing has shown that this device withstands a current of 250mA.

Table 1
Reliability Evaluation Test Results

MAX2120CTI+T

| TEST ITEM | TEST CONDITION | FAILURE IDENTIFICATION | SAMPLE SIZE | NUMBER OF FAILURES | COMMENTS |
|----------------------------------|--|----------------------------------|-------------|--------------------|----------------------|
| Static Life Test (Note 1) | Ta = 135C Biased Time = 192 hrs. | DC Parameters & functionality | 48 | 0 | SY20F3014D, D/C 0716 |

Note 1: Life Test Data may represent plastic DIP qualification lots.